

## APFA2507R9Y2C

2.5 x 0.7 mm Right Angle SMD Chip LED Lamp



### DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

### FEATURES

- 2.5 x 1.0 x 0.7 mm right angle SMD LED, 0.7 mm thickness
- Low power consumption
- Wide viewing angle
- Ideal for backlight and indicator
- Package: 3000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- Halogen-free
- RoHS compliant

### APPLICATIONS

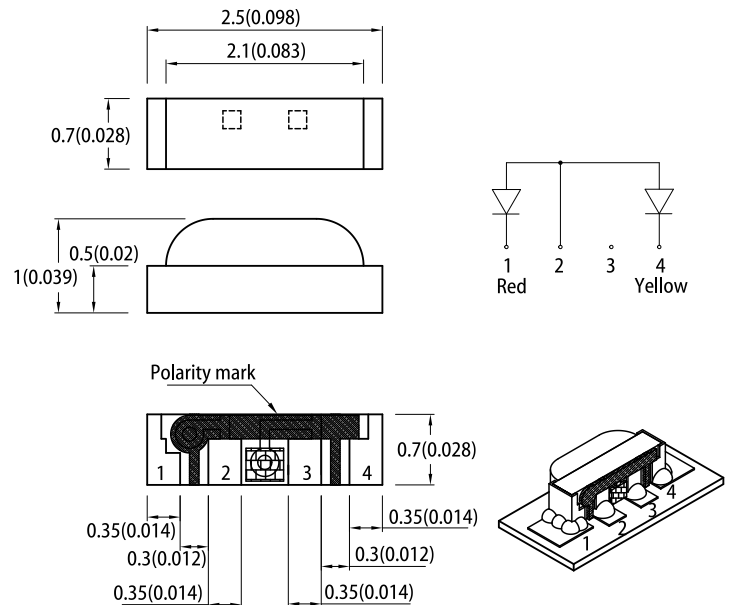
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

### ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

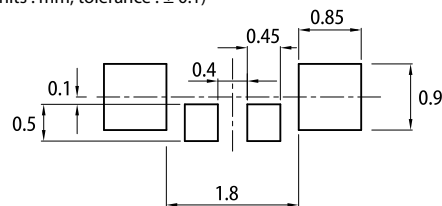


### PACKAGE DIMENSIONS



### RECOMMENDED SOLDERING PATTERN



(units : mm; tolerance :  $\pm 0.1$ )



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.15(0.006")$  unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.
5. For right angle SMD LEDs, the solder stencil should be at least 5mil in thickness, to prevent poor solder wetting due to insufficient solder paste.

### SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>
			Min.	Typ.	2θ1/2
APFA2507R9Y2C	 Hyper Red (AlGaInP)	Water Clear	80	110	130°
			*20	*40	
	 Super Bright Yellow (AlGaInP)		80	130	
			*80	*130	

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux:  $\pm 15\%$ .

\* Luminous intensity value is traceable to CIE127-2007 standards.

**ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C**

Parameter	Symbol	Emitting Color	Value		Unit
			Typ.	Max.	
Wavelength at Peak Emission I <sub>F</sub> = 20mA	$\lambda_{\text{peak}}$	Hyper Red Super Bright Yellow	630 590	-	nm
Dominant Wavelength I <sub>F</sub> = 20mA	$\lambda_{\text{dom}}^{[1]}$	Hyper Red Super Bright Yellow	621 590	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 20mA	$\Delta\lambda$	Hyper Red Super Bright Yellow	20 20	-	nm
Capacitance	C	Hyper Red Super Bright Yellow	25 20	-	pF
Forward Voltage I <sub>F</sub> = 20mA	V <sub>F</sub> <sup>[2]</sup>	Hyper Red Super Bright Yellow	2.0 2.0	2.5 2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Hyper Red Super Bright Yellow	-	10 10	μA
Temperature Coefficient of $\lambda_{\text{peak}}$ I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub><math>\lambda_{\text{peak}}</math></sub>	Hyper Red Super Bright Yellow	0.13 0.12	-	nm/°C
Temperature Coefficient of $\lambda_{\text{dom}}$ I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub><math>\lambda_{\text{dom}}</math></sub>	Hyper Red Super Bright Yellow	0.06 0.07	-	nm/°C
Temperature Coefficient of V <sub>F</sub> I <sub>F</sub> = 20mA, -10°C ≤ T ≤ 85°C	TC <sub>V</sub>	Hyper Red Super Bright Yellow	-1.9 -1.9	-	mV/°C

## Notes:

1. The dominant wavelength ( $\lambda_d$ ) above is the setup value of the sorting machine. (Tolerance  $\lambda_d$ : ±1nm.)

2. Forward voltage: ±0.1V.

3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

**ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C**

Parameter	Symbol	Value		Unit
		Hyper Red	Super Bright Yellow	
Power Dissipation	P <sub>D</sub>	75	75	mW
Reverse Voltage	V <sub>R</sub>	5	5	V
Junction Temperature	T <sub>j</sub>	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 to +85		°C
Storage Temperature	T <sub>stg</sub>	-40 to +85		°C
DC Forward Current	I <sub>F</sub>	30	30	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	195	175	mA
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	640	730	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	530	620	°C/W

## Notes:

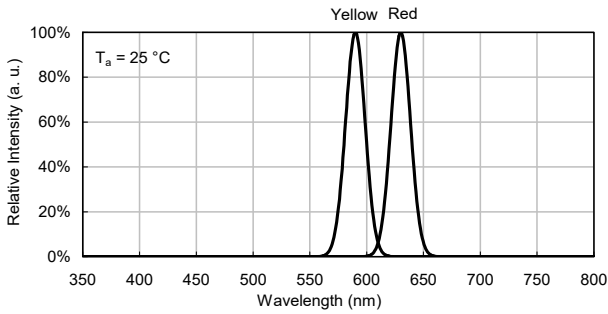
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R<sub>th JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad).

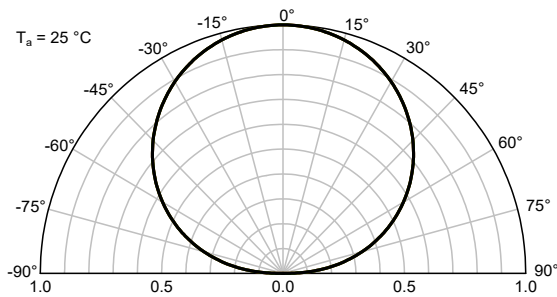
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

TECHNICAL DATA

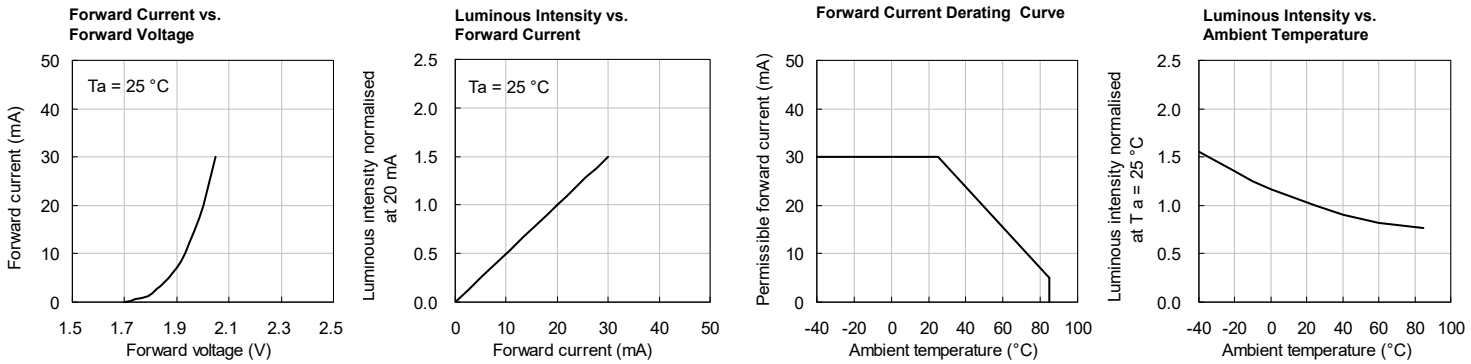
RELATIVE INTENSITY vs. WAVELENGTH



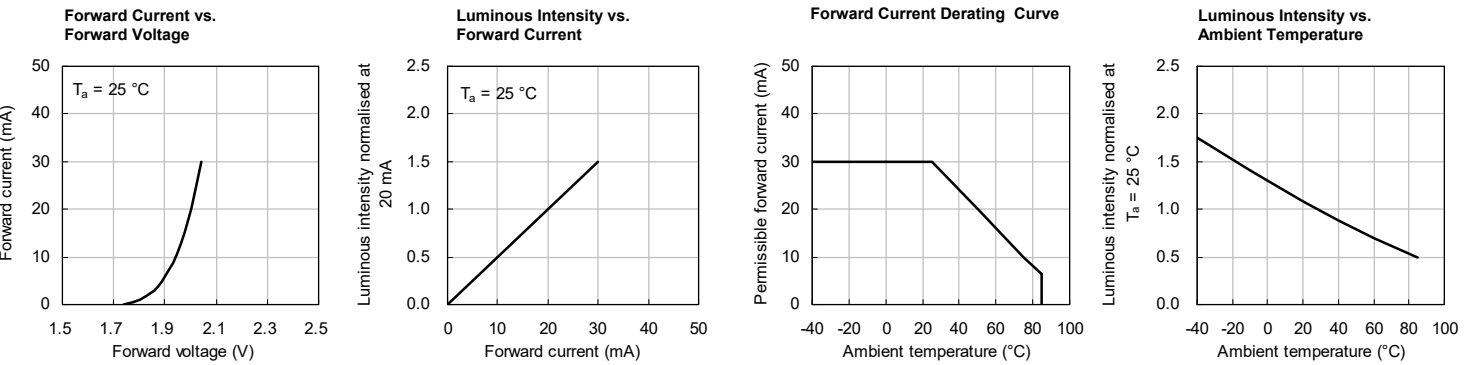
SPATIAL DISTRIBUTION



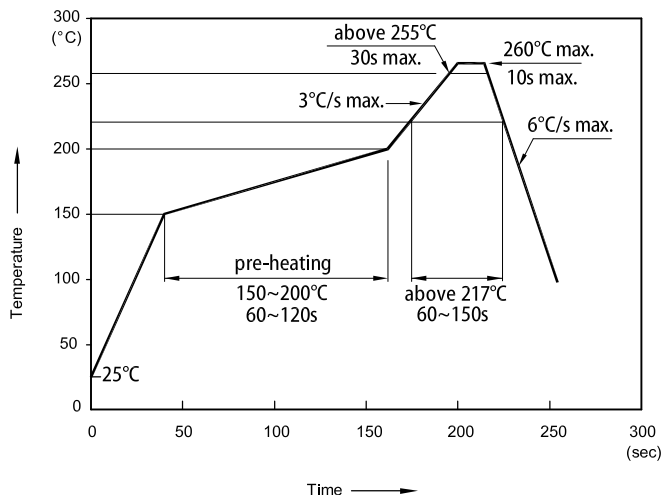
HYPER RED



SUPER BRIGHT YELLOW

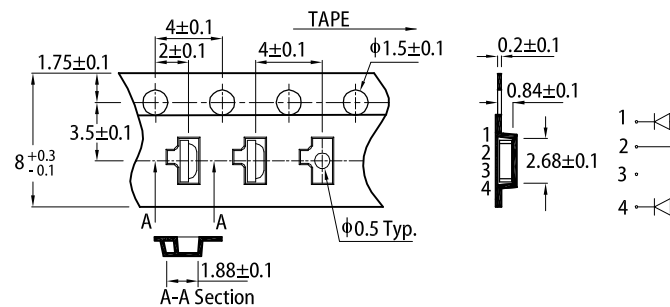


## REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

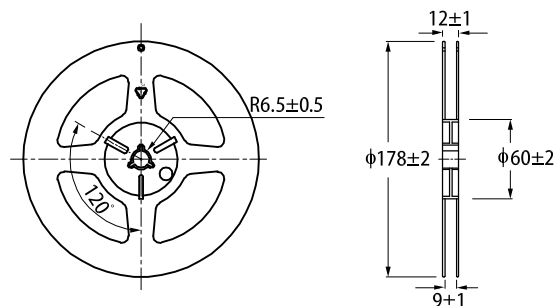


- Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
  2. The maximum number of reflow soldering passes is 2 times.
  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

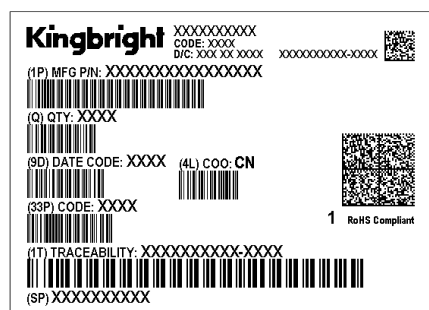
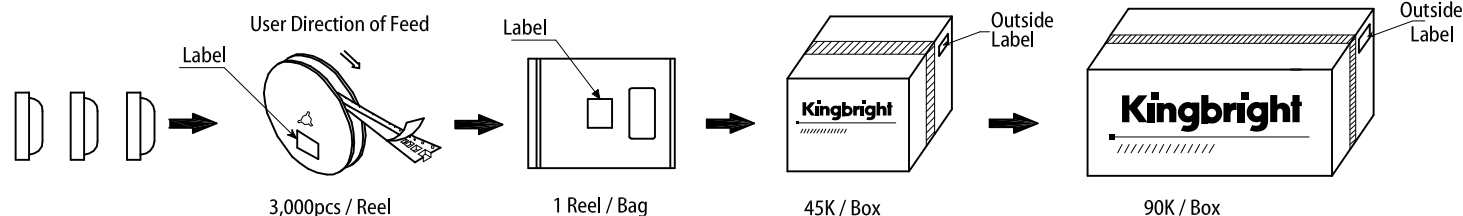
## TAPE SPECIFICATIONS (units : mm)



## REEL DIMENSION (units : mm)



## PACKING & LABEL SPECIFICATIONS



## PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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